

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

注:

1. 机械性能:

插入力:35N Max.

拔出力:10N Min.

储存温度: -20℃~65℃

2. 电性能:

额定电流:1.5A Max.

接触阻抗:30 mΩ Max.

耐高压:500V AC Min.

绝缘阻抗:1000 MΩ Min.

3. 原材料:Material:

1. 胶芯:insulater:PBT

2. 端子>Contact:Copper Alloy C2680

3. 外壳:Shell: Copper Alloy C2680/SPCC

电镀:Finish:

1. 端子>Contact: Plated Gold in Mating Area;
Tin On Solder Tails

端子四周镀50U" (MIN) 锡, 镀金区域镀100-200U" 镀金1~3U"

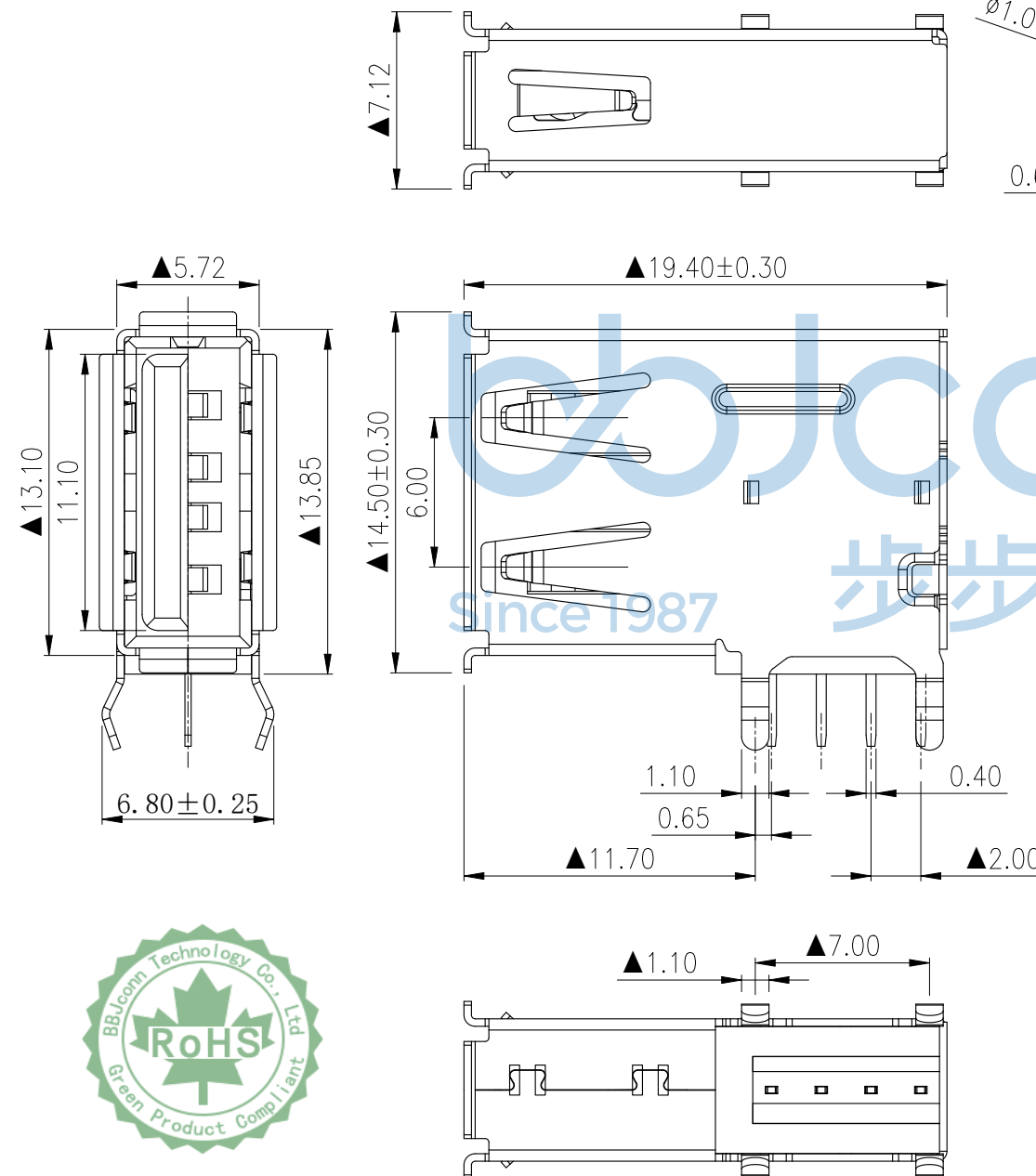
2. 外壳:Shell:

铜壳四周镀80U" (MIN) 锡

Nickel Plating

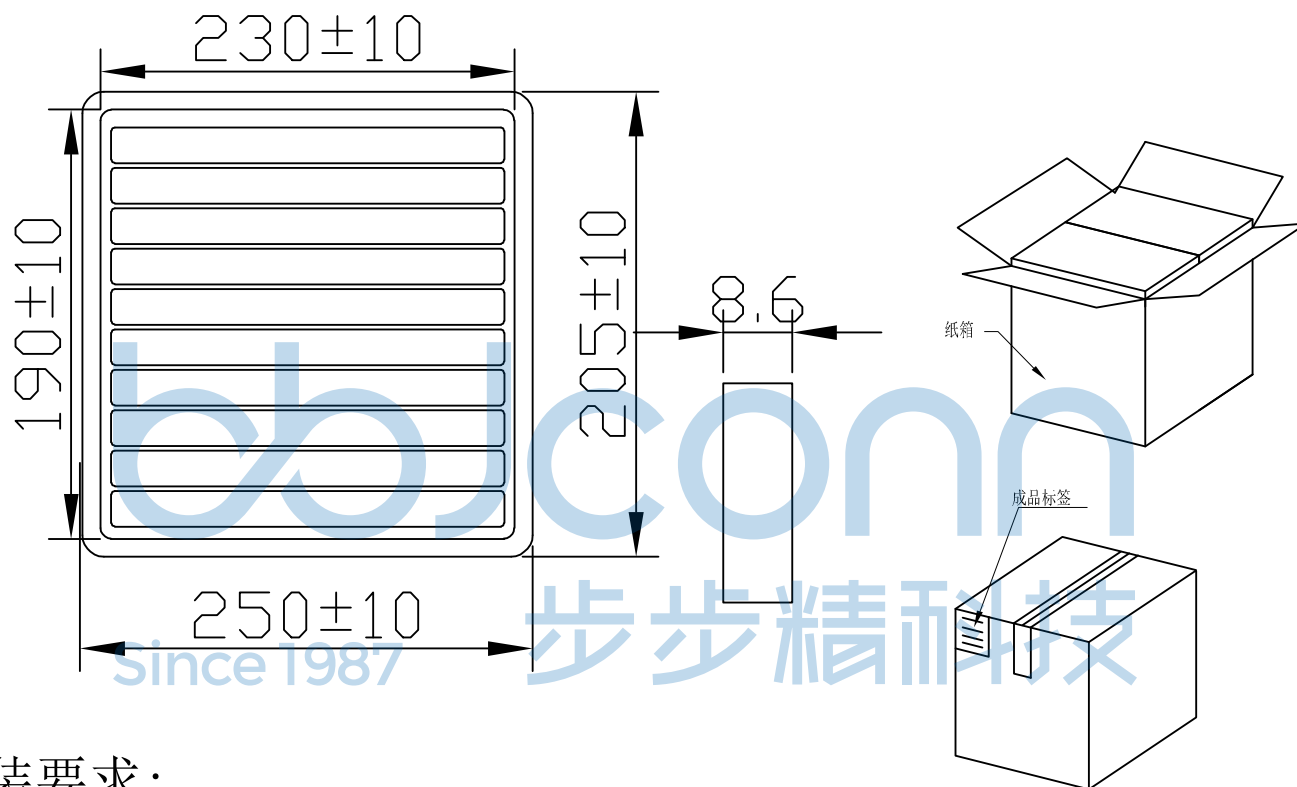


Recommend PCB layout



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PDWG.NO: 0383-1

深圳市步步精科技有限公司		NAME: USB 2.0 AF 侧插长体 L=19.40 H=13.85 弯脚 脚距6.80 端子DIP 卷边 PBT黑胶 铜壳	
.X: ±0.38	.X': ±3'	PJ. NO.: UB.01.41-12-V001	
.XX: ±0.25	.X': ±2'	SIZE: A4 DRW NO.:	
.XXX: ±0.13	.XX': ±1'	FINISH: SEE NOTES MAT'L.: SEE NOTES	
APPD. JM_Zheng	CHKD. LYX	SCALE: N/A	REV.: A0
DR. TSP		UNIT: mm	PAGE: 1/2



纸箱规格: 350*210*290

1. 包装要求:
- 1.1 每盒吸塑盒包装100pcs;
- 1.2 每20盘放一箱, 共计2000PCS;
- 1.3 纸箱外贴上标签。

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APPD.	JM_Zheng	PJ. NO.: UB.01.41-12-V001	
CHKD.	LYX	SIZE: A4 DRW NO.:	
DR.	TSP	FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0 UNIT: mm PAGE: 2/2